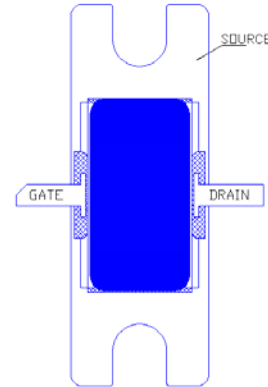


- **PERFORMANCE (1.8 GHz)**
 - ◆ 40 dBm Output Power (P_{1dB})
 - ◆ 11 dB Power Gain (G_{1dB})
 - ◆ -44 dBc WCDMA ACPR at 30 dBm output power
 - ◆ 180 to 300 mA typical quiescent current (I_{DQ})
 - ◆ 55% Power-Added Efficiency
 - ◆ Evaluation Boards Available
 - ◆ Additional Design Data Available on Website
 - ◆ Usable Gain to 3.8GHz



**SEE PACKAGE
OUTLINE FOR
MARKING CODE**

DESCRIPTION AND APPLICATIONS

The FPD10000AF is a packaged depletion mode AlGaAs/InGaAs pseudomorphic High Electron Mobility Transistor (pHEMT), optimized for power applications in L-Band. The high power flange-mount package has been optimized for low electrical parasitics and optimal heatsinking.

Typical applications include drivers or output stages in PCS/Cellular base station transmitter amplifiers, as well as other power applications in WLL/WLAN amplifiers.

ELECTRICAL SPECIFICATIONS AT 22°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
RF SPECIFICATIONS MEASURED AT $f = 1.8$ GHz USING CW SIGNAL						
Power at 1dB Gain Compression Class B Operation	P_{1dB}	$V_{DS} = 12V$; $I_{DQ} = 180$ mA		40		dBm
Power Gain at dB Gain Compression	G_{1dB}	$V_{DS} = 12V$; $I_{DQ} = 180$ mA $V_{DS} = 12V$; $I_{DQ} = 300$ mA		10 11		dB
Maximum Stable Gain: S_{21}/S_{12} $P_{IN} = 0$ dBm, 50Ω system	MSG	$V_{DS} = 12$ V; $I_{DQ} = 180$ mA $V_{DS} = 12$ V; $I_{DQ} = 300$ mA		16.5 18.0		dB
Power-Added Efficiency at 1dB Gain Compression	PAE	$V_{DS} = 12V$; $I_{DQ} = 180$ mA I_{RF} (drive-up current) ~ 1.5 A		55		%
Adjacent Channel Power Ratio WCDMA BTS Forward (64 channels) 10.15 dB Pk/Avg 0.001%	ACPR	$V_{DS} = 12V$; $I_{DQ} = 180$ mA Channel power = 30 dBm		-44		dBc
Saturated Drain-Source Current	I_{DSS}	$V_{DS} = 3.0$ V; $V_{GS} = 0$ V		5.2		A
Gate-Source Leakage Current	I_{GSO}	$V_{GS} = -3$ V		3		mA
Pinch-Off Voltage	$ V_P $	$V_{DS} = 3.0$ V; $I_{DS} = 19$ mA		1.1		V
Gate-Drain Breakdown Voltage	$ V_{BDGD} $	$I_{GD} = 19$ mA	30	35		V
Thermal Resistivity (channel-to-case)	Θ_{CC}	See Note on following page		3.5		°C/W

• RECOMMENDED OPERATING BIAS CONDITIONS

Drain-Source Voltage: From 10 to 12V
 Quiescent Current: From 180 (Class B) to 300 mA (Class AB) operation

• ABSOLUTE MAXIMUM RATINGS¹

Parameter	Symbol	Test Conditions	Min	Max	Units
Drain-Source Voltage	V_{DS}	$-3V < V_{GS} < +0V$		16	V
Gate-Source Voltage	V_{GS}	$0V < V_{DS} < +15V$		-3	V
Drain-Source Current	I_{DS}	For $V_{DS} > 2V$		50% I_{DSS}	mA
Gate Current	I_G	Forward / Reverse current		+50/-8	mA
RF Input Power ²	P_{IN}	Under any acceptable bias state		1.75	W
Channel Operating Temperature	T_{CH}	Under any acceptable bias state		175	°C
Storage Temperature	T_{STG}	Non-Operating Storage	-40	150	°C
Total Power Dissipation	P_{TOT}	See De-Rating Note below		42	W
Gain Compression	Comp.	Under any bias conditions		5	dB
Simultaneous Combination of Limits ³		2 or more Max. Limits		80	%

¹ $T_{Ambient} = 22^{\circ}C$ unless otherwise noted ²Max. RF Input Limit must be further limited if input VSWR > 2.5:1

³Users should avoid exceeding 80% of 2 or more Limits simultaneously

Notes:

- Operating conditions that exceed the Absolute Maximum Ratings will result in permanent damage to the device.
- Total Power Dissipation defined as: $P_{TOT} \equiv (P_{DC} + P_{IN}) - P_{OUT}$, where:
 P_{DC} : DC Bias Power
 P_{IN} : RF Input Power
 P_{OUT} : RF Output Power

- Total Power Dissipation to be de-rated as follows above $22^{\circ}C$:
 $P_{TOT} = 42 - (0.286W/^{\circ}C) \times T_{PACK}$
 where T_{PACK} = source tab lead temperature above $22^{\circ}C$
 (coefficient of de-rating formula is the Thermal Conductivity)

Example: For a $55^{\circ}C$ Source flange temperature: $P_{TOT} = 42 - (0.286 \times (55 - 22)) = 32.6W$

- Note on Thermal Resistivity:* The nominal value of $3.5^{\circ}C/W$ is measured with the package mounted on a large heatsink with thermal compound to ensure adequate contact. The package temperature is referred to the Source flange.

• HANDLING PRECAUTIONS

To avoid damage to the devices care should be exercised during handling. Proper Electrostatic Discharge (ESD) precautions should be observed at all stages of storage, handling, assembly, and testing. These devices should be treated as Class 1A per ESD-STM5.1-1998, Human Body Model. Further information on ESD control measures can be found in MIL-STD-1686 and MIL-HDBK-263.

BIASING GUIDELINES

- Dual-bias (separate positive Drain and negative Gate supplies) circuits are recommended, requiring a regulated negative voltage supply for depletion-mode devices such as the FPD10000AF. The Gate bias supply should be capable of sinking / sourcing at least 10mA of current. The bias circuitry must be properly sequenced to ensure that the control Gate voltage (typically -0.6 to -1.0V) is applied to the device *before* the Drain voltage, otherwise large amounts of Drain-Source current will be drawn, potentially leading to instability and self-oscillation.
- The recommended 180 – 300 mA bias point is nominally a Class B/AB mode. A small amount of RF gain expansion prior to the onset of compression is normal for this operating point, and significant current drive-up should be expected. If a Class A operation is desired, users should check the de-rating limits given in the previous section to ensure reliable operation.

PACKAGE OUTLINE (dimensions in millimeters – mm)

PACKAGE MARKING CODE

Example:

**f1ZD
P3F**

f = Filtronic

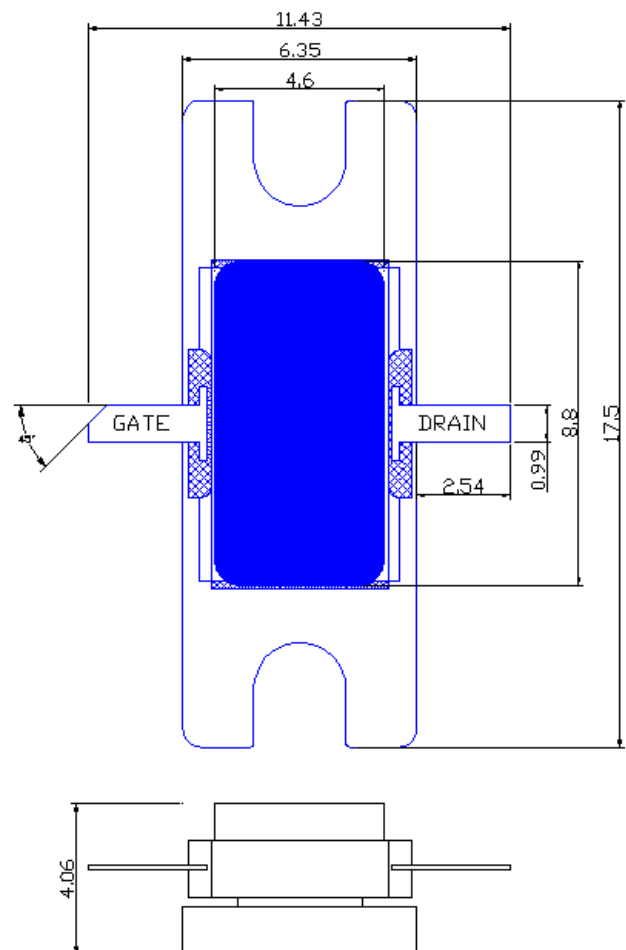
1ZD = Lot and Date Code

P2F = Status, Part Code, Part Type

Status: D=Development P = Production

Part Code denotes model (e.g. FPD10000AF)

Part Type: F = FET (pHEMT)



All information and specifications subject to change without notice.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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